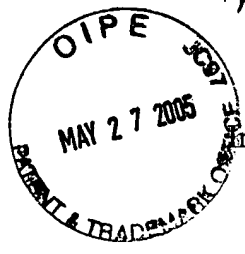


OIP

MAY 27 2005

Attorney's Docket No.: 042390P12141

Patent



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Ashay A. Dani, et al.

Application No.: 10/038,334

Filed: October 18, 2001

For: THERMAL INTERFACE MATERIAL  
AND ELECTRONIC ASSEMBLY  
HAVING SUCH A THERMAL  
INTERFACE MATERIAL

Examiner: Sheeba Ahmed

Art Unit: 1773

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated February 25, 2005, Applicant respectfully requests that the above-identified application be amended as follows and that the following remarks be considered:

FIRST-CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail with sufficient postage in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia, 22313-1450, on:

May 25, 2005

Date of Deposit

Linda K. Brost

Name of Person Mailing Correspondence

*Linda K. Brost*  
Signature

*May 25, 2005*  
Date

Ashay A. Dani, et al.  
Application No.: 10/038,334

Examiner: Sheeba Ahmed  
Art Unit: 1773